

RoHS

COMPLIANT

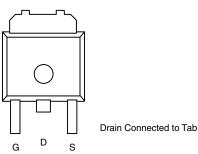
HALOGEN FREE

TK8S06K3L-VB Datasheet

N-Channel 60 V (D-S) MOSFET

| PRODU | PRODUCT SUMMARY | | | | |
|---------------------|---------------------------------|--------------------|-----------------------|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) Max. | I _D (A) | Q _g (Typ.) | | |
| 60 | 0.073 at V _{GS} = 10 V | 18 | 19.8 | | |
| | 0.085 at V_{GS} = 4.5 V | 15 | 19.0 | | |





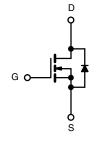
FEATURES

- TrenchFET[®] Power MOSFET
- + 100 % $\rm R_g$ and UIS Tested

• Material categorization: For definitions of compliance please see

APPLICATIONS

- DC/DC Converters
- DC/AC Inverters
- Motor Drives



N-Channel MOSFET

| ABSOLUTE MAXIMUM RAT | FINGS (T _C = 25 °C, unless o | otherwise noted) | | |
|--|--|-----------------------------------|-------------------|-----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | | V _{DS} | 60 | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | v |
| Continuous Drain Current | T _C = 25 °C | 1 | 18 | |
| Continuous Drain Current | T _C = 70 °C | I _D | 14 | A |
| Pulsed Drain Current (t = 300 μs) | | I _{DM} | 25 | A |
| Avalanche Current | | I _{AS} | 15 | |
| Single Avalanche Energy ^a | L = 0.1 mH | E _{AS} | 11.25 | mJ |
| Maximum Power Dissipation ^a | T _C = 25 °C | Р | 41.7 ^b | |
| | T _A = 25 °C ^c | P _D | 2.1 | - W |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C |

| THERMAL RESISTANCE RATINGS | | | |
|--|-------------------|-------|------|
| Parameter | Symbol | Limit | Unit |
| Junction-to-Ambient (PCB Mount) ^c | R _{thJA} | 60 | °C/W |
| Junction-to-Case (Drain) | R _{thJC} | 3 | 0/11 |

Notes:

a. Duty cycle \leq 1 %.

b. See SOA curve for voltage derating.

c. When mounted on 1" square PCB (FR-4 material).

d. Base on T_C = 25 °C.



| \mathcal{B}° | Bsemi |
|-----------------------|----------|
| www.VB | semi.com |

| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------|---|------|-------|-------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$ | 60 | | | v | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$ | 1.0 | | 3.0 | v | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | ± 250 | nA | |
| | | $V_{DS} = 60 V, V_{GS} = 0 V$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 125 \text{ °C}$ | | | 50 | μA | |
| | | $V_{DS} = 60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$ | | | 250 | 1 | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 20 | | | Α | |
| | | V _{GS} = 10 V, I _D = 6.6 A | | 0.073 | | | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6 \text{ A}$ | | 0.085 | | Ω | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 6.6 A | | 25 | | S | |
| Dynamic ^b | | | | • | | | |
| Input Capacitance | C _{iss} | | | 660 | | pF | |
| Output Capacitance | C _{oss} | V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz | | 85 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 40 | | | |
| Total Gate Charge ^c | Qq | | | 19.8 | 30 | nC | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 6.6 \text{ A}$ | | 3.6 | | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 4.1 | | | |
| Gate Resistance | R _g | f = 1 MHz | 0.4 | 2 | 4 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 8 | 16 | | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V}, \text{ R}_{I} = 9.6 \Omega$ | | 11 | 20 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 5.2 \text{ Å}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$ | | 18 | 27 | | |
| Fall Time ^c | t _f | | | 5 | 10 | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 38 | 57 | ns | |
| Rise Time ^c | t _r | $V_{DD} = 30 \text{ V}, \text{ R}_{I} = 9.6 \Omega$ | | 58 | 87 | - | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 5.2$ Å, $V_{GEN} = 4.5$ V, $R_g = 1 \Omega$ | | 18 | 27 | | |
| Fall Time ^c | t _f | | | 8 | 16 | | |
| Drain-Source Body Diode Ratings a | nd Characteri | stics ^b T _C = 25 °C | | | | | |
| Continuous Current | ۱ _S | | | | 18 | _ | |
| Pulsed Current | I _{SM} | | | | 25 | A | |
| Forward Voltage ^a | V _{SD} | I _F = 5.2 A, V _{GS} = 0 V | | 0.8 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 34 | 51 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 5.2 A, dl/dt = 100 A/μs | | 3 | 5 | Α | |
| Reverse Recovery Charge | Q _{rr} | | | 50 | 75 | nC | |

Notes:

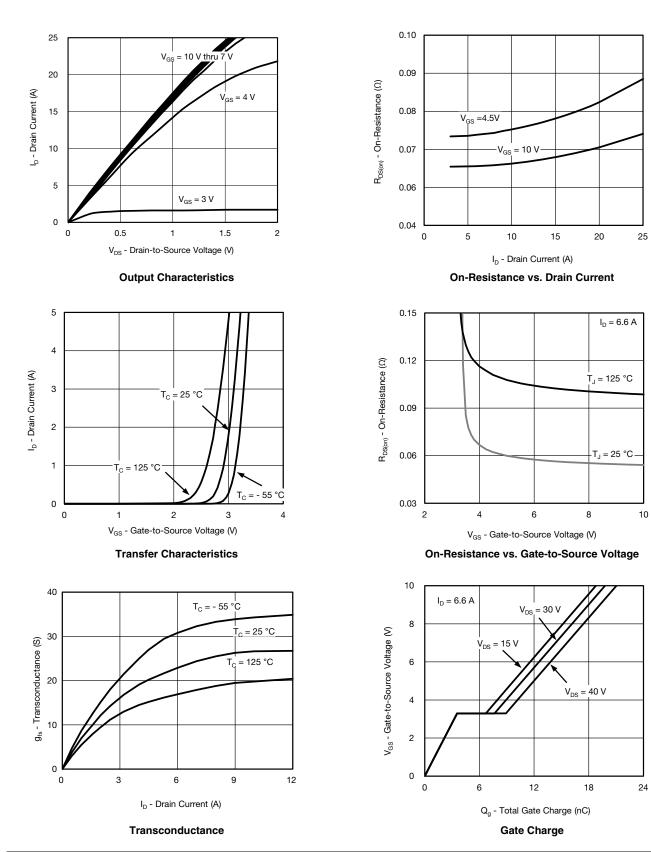
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



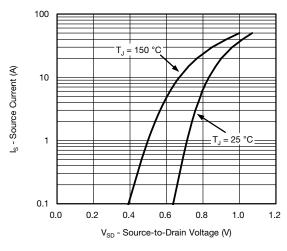


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

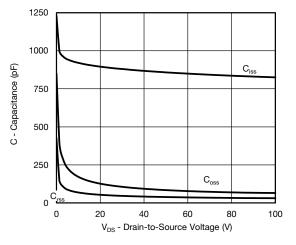
服务热线:400-655-8788



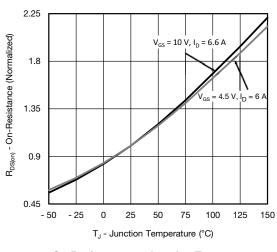
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



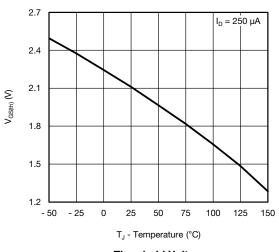
Source-Drain Diode Forward Voltage



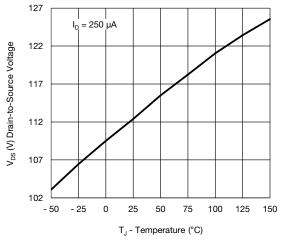




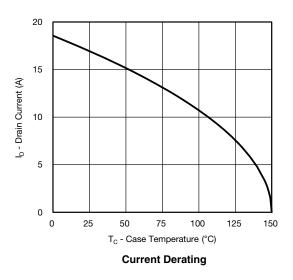
On-Resistance vs. Junction Temperature



Threshold Voltage

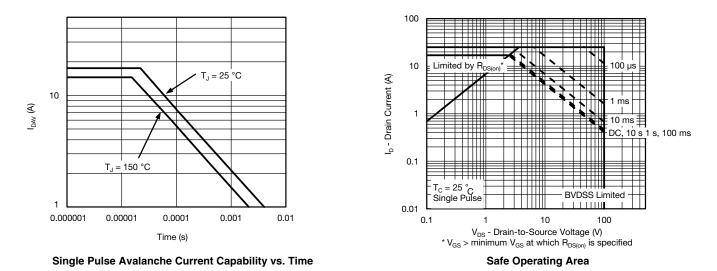


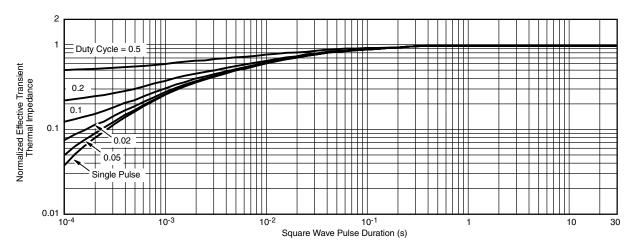
Drain Source Breakdown vs. Junction Temperature





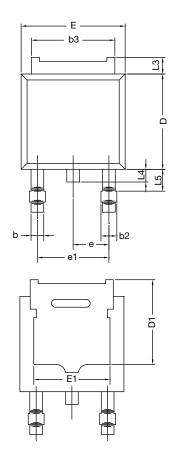
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



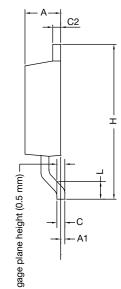


Normalized Thermal Transient Impedance, Junction-to-Case





TO-252AA Case Outline



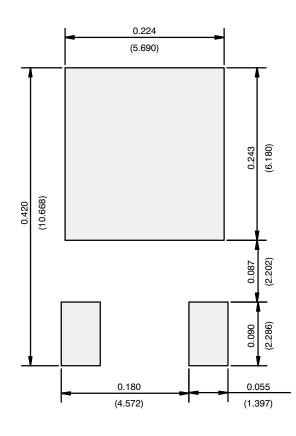
| | MILLIMETERS | | INCHES | | |
|-----------------------|--------------------------------|-----------|-----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 2.18 | 2.38 | 0.086 | 0.094 | |
| A1 | - | 0.127 | - | 0.005 | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | - | 0.161 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| е | 2.28 BSC | | 0.090 BSC | | |
| e1 | 4.56 BSC | | 0.180 BSC | | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | |
| ECN: T16- DWG: 534 | 0236-Rev. P, ⁻ 7 | 16-May-16 | - | - | |

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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